

PRODUCT NUMBER
98423-X61-XXXLF

PLATING
S = 0.38µm GOLD/GXT
ON CONTACT AREA
3.81µm TIN LEAD
ON TAIL
G = 0.76µm GOLD/GXT
ON CONTACT AREA
3.81µm TIN LEAD
ON TAIL
F = GOLD FASH
ON CONTACT AREA
3.81µm TIN LEAD
ON TAIL

WHEN REQUIRED, ADD SUFFIX LETTER "LF"
INDICATES THE PRODUCT IS RoHS
COMPATIBLE, SEE NOTE 6

PACKAGING OPTIONAL LETTER (SEE NOTE 5)

NB OF POSITIONS PER ROW
02 TO 25 POS

NOTES:

1. MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC
UL 94V-0, COLOR BLACK
2. MATERIAL TERMINAL: COPPER ALLOY
3. TO DETERMINE DIMENSIONS:
N = NUMBER OF POSITIONS PER ROW
4. 7N MIN. PIN RETENTION IN EITHER DIRECTION.
5. PACKAGING:
= PLASTIC BOX
U = TUBE AVAILABLE FROM 06 TO 50 POS
6. RoHS COMPATIBLE PRODUCT SPECIFICATIONS

a - PLATING:

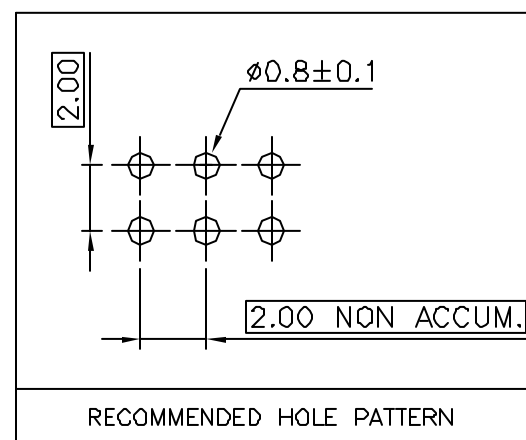
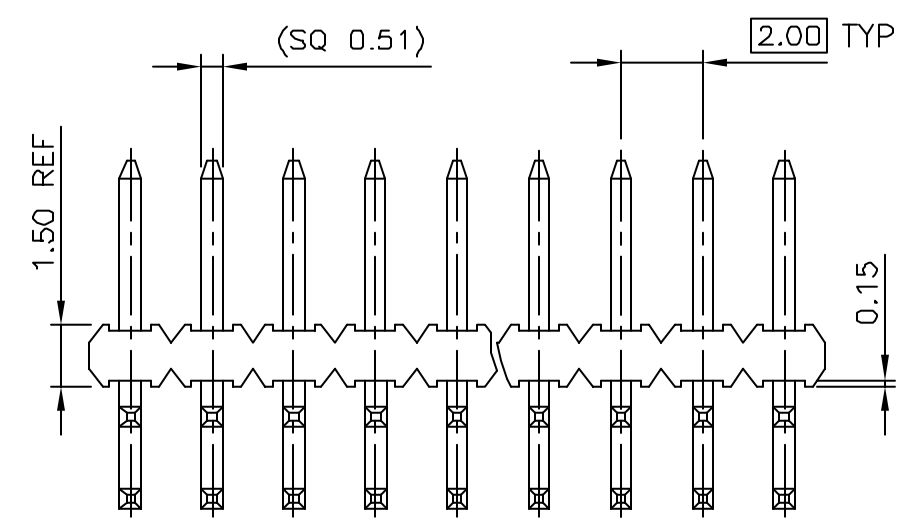
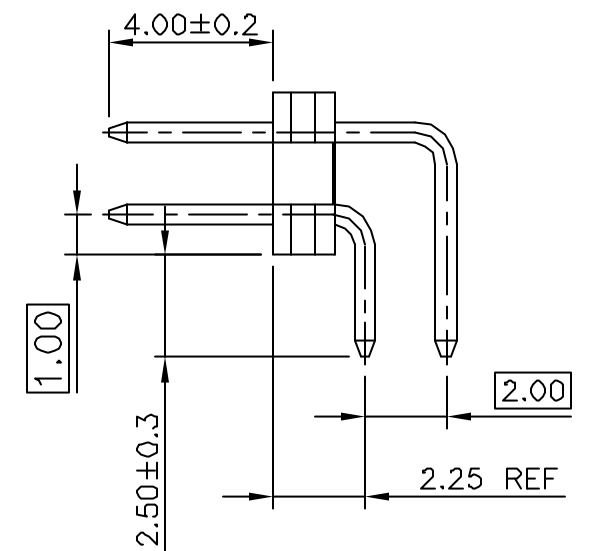
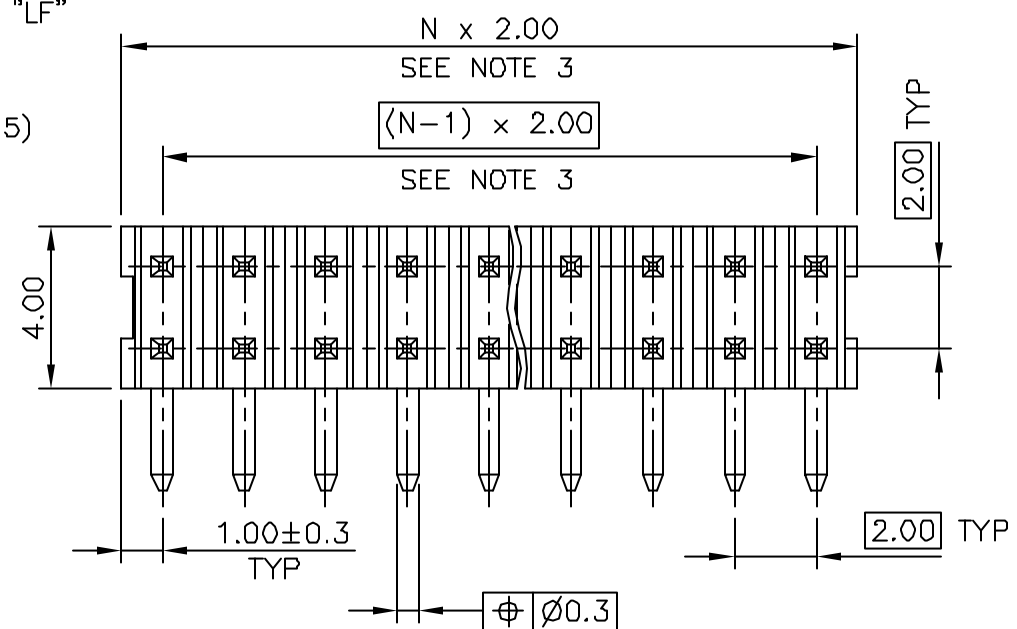
- "LF" MEANS THE PRODUCT IS LEAD-FREE,
2µm MINIMUM MATTE TIN OVER 1.27µm
MINIMUM NICKEL UNDERPLATE.

b - MANUFACTURING PROCESS COMPATIBILITY

- THE HOUSING WILL WITHSTAND EXPOSURE TO
260°C ±5°C SOLDER BATH TEMPERATURE FOR
5 SECONDS IN A WAVE SOLDER APPLICATION
WITH A 1.6mm MIN THICK CIRCUIT BOARD.

c - LABELLING:

- MEETS PACKAGING SPECS AS PER GS-14-920
- THIS PRODUCT MEETS EUROPEAN DIRECTIVES
AND OTHER COUNTRY REGULATIONS AS DISCRIBED
IN GS-22-008.



mat'l. code				surface	tolerance	projection	product family	
				ISO 1302	ISO 406	ISO 101	MINITEK	
ltr	ecn no	dr	date	tolerances unless otherwise specified		mm	title	
A	F10338	LMU	03.10.01	angles	X ±0.3		UNSHR HEADER	
B	F04-0351	JCO	05.01.13	linear	X.X ±0.13	scale 1:1	RIGHT ANGLE TMT	
C	F06-0210	LMU	06.07.05		X.XX ±0.05		dwg no	
D	F08-0145	ELA	17.04.08	dr	L MULIN	04.09.28	sheet 1 of 1	
				engr	J. COMPAGNON	04.09.28	size	
				chr			98423	
				appd	JM.C	04.09.28	type	
							CUSTOMER Drawing	
sheet	revision							
index	sheet							